

PTUC0516N – ESD Protection Diode

Feature

- 30 Watts peak pulse power (8/20μs)
- Tiny DFN3310 package
- Protect up to six lines
- Solid state silicon-avalanche technology
- Low clamping voltage
- Low leakage current
- Low capacitance (C_j = 0.2 pF typ. I/O to I/O)
- IEC61000-4-2 (ESD) ±15kV (Air), ±8kV (Contact)
- IEC61000-4-4 (EFT) 40A (5/50ns)
- IEC61000-4-5 (Lightning): 3A (8/20μs)



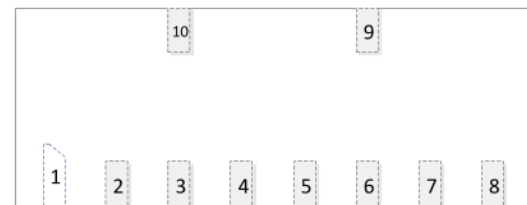
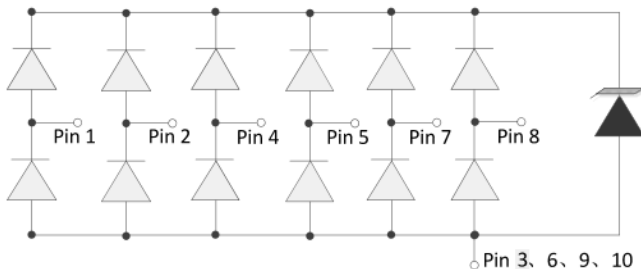
Applications

- USB3.0/3.1, Type C
- HDMI1.4/2.0, Display Port 1.3
- Unified Display Interface
- Digital Video Interface

Mechanical Data

- DFN3310 package
- Molding compound flammability rating: UL94 V-0
- Tape and Reel Packaging
- RoHS/WEEE Compliant

Schematic and PIN Configuration



Maximum Rating

| Parameter | Symbol | Limit | Unit |
|---|---------------------------------|---------|------|
| IEC61000-4-2 ESD Voltage – Air Mode | V _{ESD} ⁽¹⁾ | ±15 | KV |
| IEC61000-4-2 ESD Voltage – Contact Mode | | ±8 | |
| Peak Pulse Power | P _{PP} ⁽²⁾ | 30 | W |
| Peak Pulse Current | I _{PP} ⁽²⁾ | 3 | A |
| Maximum Lead Solder Temperature (10 seconds duration) | T _L | 260 | °C |
| Junction Temperature | T _J | -55~125 | °C |
| Storage Temperature Range | T _{stg} | -55~125 | °C |

Note:

1. Device stressed with ten non-repetitive ESD pulses.
2. Non-repetitive current pulse 8/20μs exponential decay waveform according to IEC61000-4-5.
3. All ratings are measured at environmental temperature of TA = 25 °C unless otherwise noted.

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Electrical Characteristics

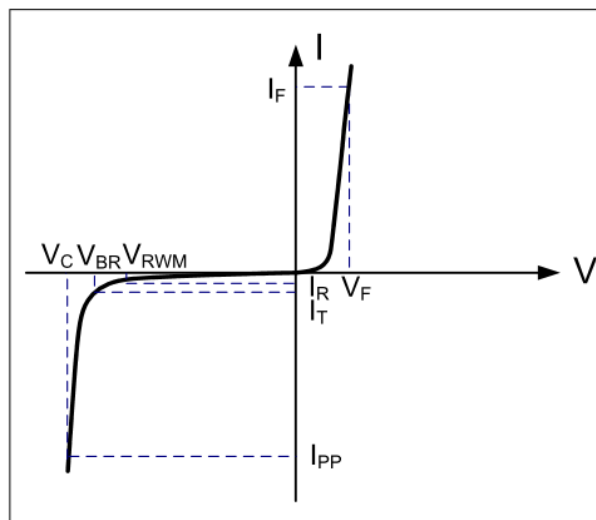
| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
|---------------------------|-----------------|--|-----|-----|-----|---------------|
| Reverse Stand-off Voltage | $V_{RWM}^{(1)}$ | | | | 5.0 | V |
| Reverse Breakdown Voltage | V_{BR} | $I_T = 1\text{mA}$ | 6.0 | 7.2 | 9.5 | V |
| Reverse Leakage Current | I_R | $V_{RWM} = 5\text{V}$ | | 0.1 | 0.5 | μA |
| Peak Pulse Current | I_{PP} | | | | 3 | A |
| Clamping Voltage | $V_C^{(2)}$ | $I_{PP} = 3\text{A}$ | | | 10 | V |
| Junction Capacitance | C_J | $V_R = 0\text{V}, f = 1\text{MHz}, I/O \text{ to } I/O$ | | 0.2 | | pF |
| | | $V_R = 0\text{V}, f = 1\text{MHz}, I/O \text{ to } \text{GND}$ | | 0.4 | | pF |

Note:

1. Other voltages available upon request.
2. Non-repetitive current pulse 8/20 μs exponential decay waveform according to IEC61000-4-5.
3. All ratings are measured at environmental temperature of $T_A = 25^\circ\text{C}$ unless otherwise noted.

Electrical Parameters

| Symbol | Parameter |
|-----------|-------------------------------------|
| V_C | Clamping Voltage @ I_{PP} |
| I_{PP} | Peak Pulse Current |
| V_{BR} | Breakdown Voltage @ I_T |
| I_T | Test Current |
| I_R | Reverse Leakage Current @ V_{RWM} |
| V_{RWM} | Reverse Stand-off Voltage |
| V_F | Forward Voltage @ I_F |



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Typical Characteristics

Fig.1 IEC61000-4-2 Waveform

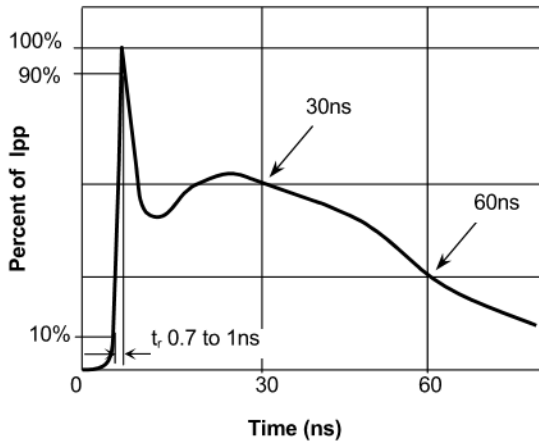


Fig.2 IEC61000-4-2 +8kV Contact ESD Clamping Waveform

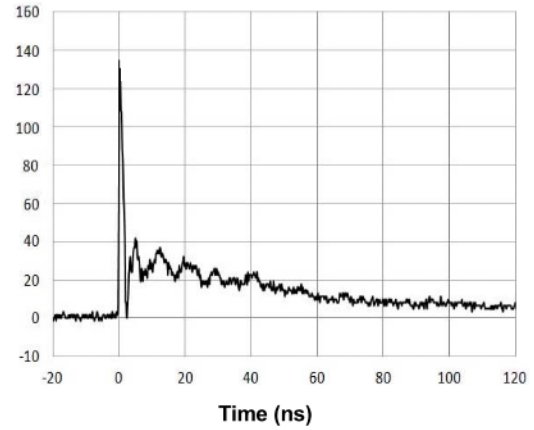


Fig.3 Eye Diagram - USB3.1 at 10Gbps per channel

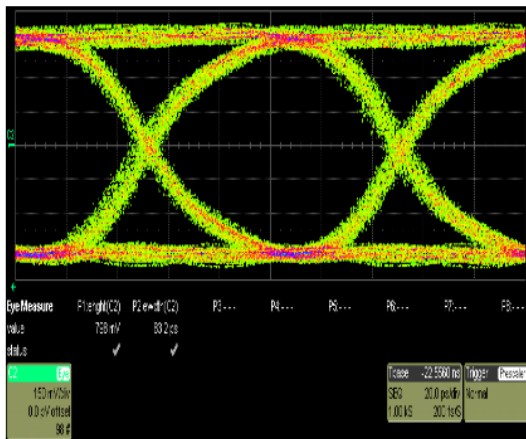
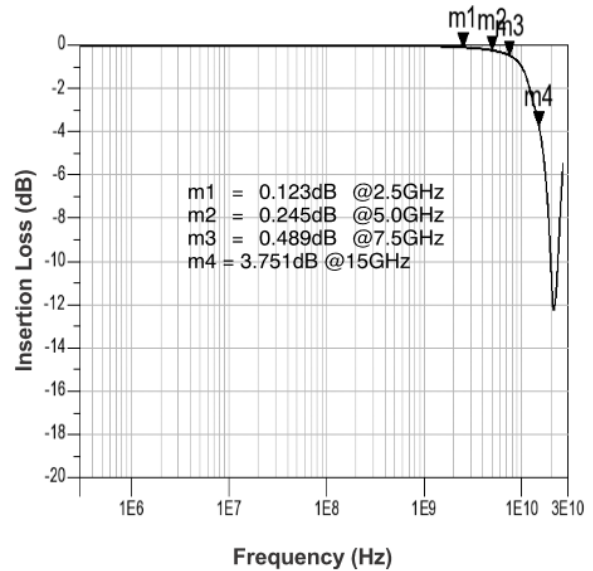
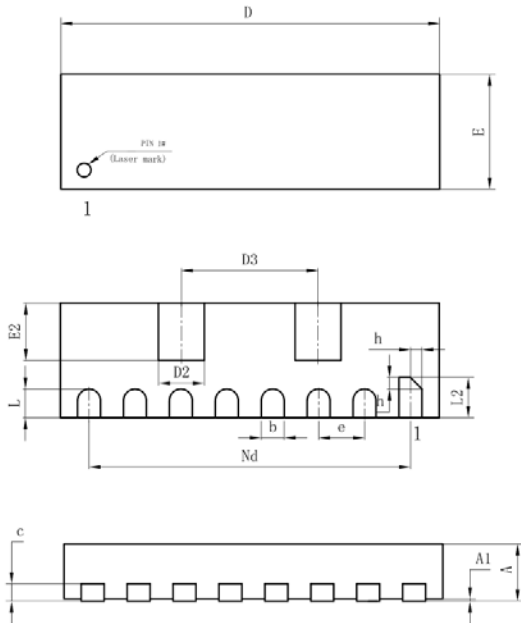


Fig.4 Insertion Loss S21 - I/O to I/O



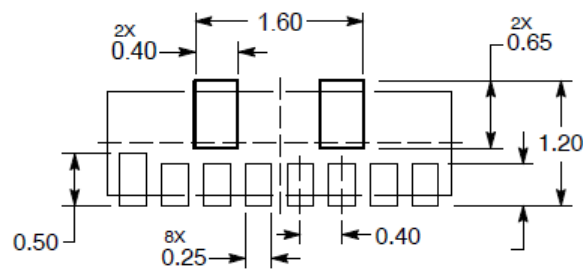
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DFN3310 Package Outline Dimensions



| Symbol | Dimensions (mm) | | |
|--------|-----------------|-------|-------|
| | Min | Typ | Max |
| A | 0.45 | 0.50 | 0.55 |
| A1 | 0.00 | 0.02 | 0.05 |
| b | 0.15 | 0.20 | 0.25 |
| c | 0.100 | 0.152 | 0.200 |
| D | 3.25 | 3.30 | 3.35 |
| D2 | 0.30 | 0.35 | 0.40 |
| D3 | 1.19 BSC | | |
| e | 0.40 BSC | | |
| Nd | 2.80 BSC | | |
| E | 0.95 | 1.00 | 1.05 |
| E2 | 0.45 | 0.50 | 0.55 |
| L | 0.20 | 0.25 | 0.30 |
| L2 | 0.30 | 0.35 | 0.40 |
| h | 0.05 | 0.10 | 0.15 |

RECOMMENDED SOLDERING FOOTPRINT



DIMENSION: MILLIMETERS

Marking



Packaging Information

| Order Code | Packaging | Reel Size | PCS/Reel |
|------------|-----------|-----------|----------|
| PTUC0516N | DFN3310 | 7 inch | 3,000 |